# **DRA4143X**

## Silicon PNP epitaxial planar type

For digital circuits Complementary to DRC4143X DRA2143X in NS through hole type package

#### Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$
- Contributes to miniaturization of sets, mount area reduction
- Eco-friendly Halogen-free package

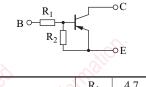
#### Packaging

DRA4143X0A Radial type: 5000 pcs / carton

### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-50	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-50	V
Collector current	I <sub>C</sub>	-100	mA
Total power dissipation	P <sub>T</sub>	300	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150 \$	°C

- Package
- Code
- NS-B2-B-B
  - Package dimension clicks here. $\rightarrow$
- Pin Name
  - 1: Emitter
  - 2: Collector
  - 3: Base
- Marking Symbol: L6
- Internal Connection



	112			
Resistance value	R <sub>2</sub>	10	kΩ	
Desistance value	$R_1$	4.7	kΩ	

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = -10 \mu {\rm A}, I_{\rm E} = 0$	-50			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$	-50			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{\rm CB} = -50 \text{ V}, I_{\rm E} = 0$			- 0.1	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{\rm CE} = -50 \text{ V}, I_{\rm B} = 0$			- 0.5	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{\rm EB} = -6 \text{ V}, I_{\rm C} = 0$			-1.0	mA
Forward current transfer ratio	$\mathbf{h}_{\mathrm{FE}}$	$V_{\rm CE} = -10$ V, $I_{\rm C} = -5$ mA	30			—
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -0.5 \text{ mA}$			-0.25	V
Input voltage (ON)	V <sub>I(on)</sub>	$V_{\rm CE} = -0.2$ V, $I_{\rm C} = -5$ mA	-1.7			V
Input voltage (OFF)	V <sub>I(off)</sub>	$V_{CE} = -5 \text{ V}, I_C = -100 \mu\text{A}$			- 0.6	V
Input resistance	R <sub>1</sub>		-30%	4.7	+30%	kΩ
Resistance ratio	$R_1/R_2$		0.37	0.47	0.57	

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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